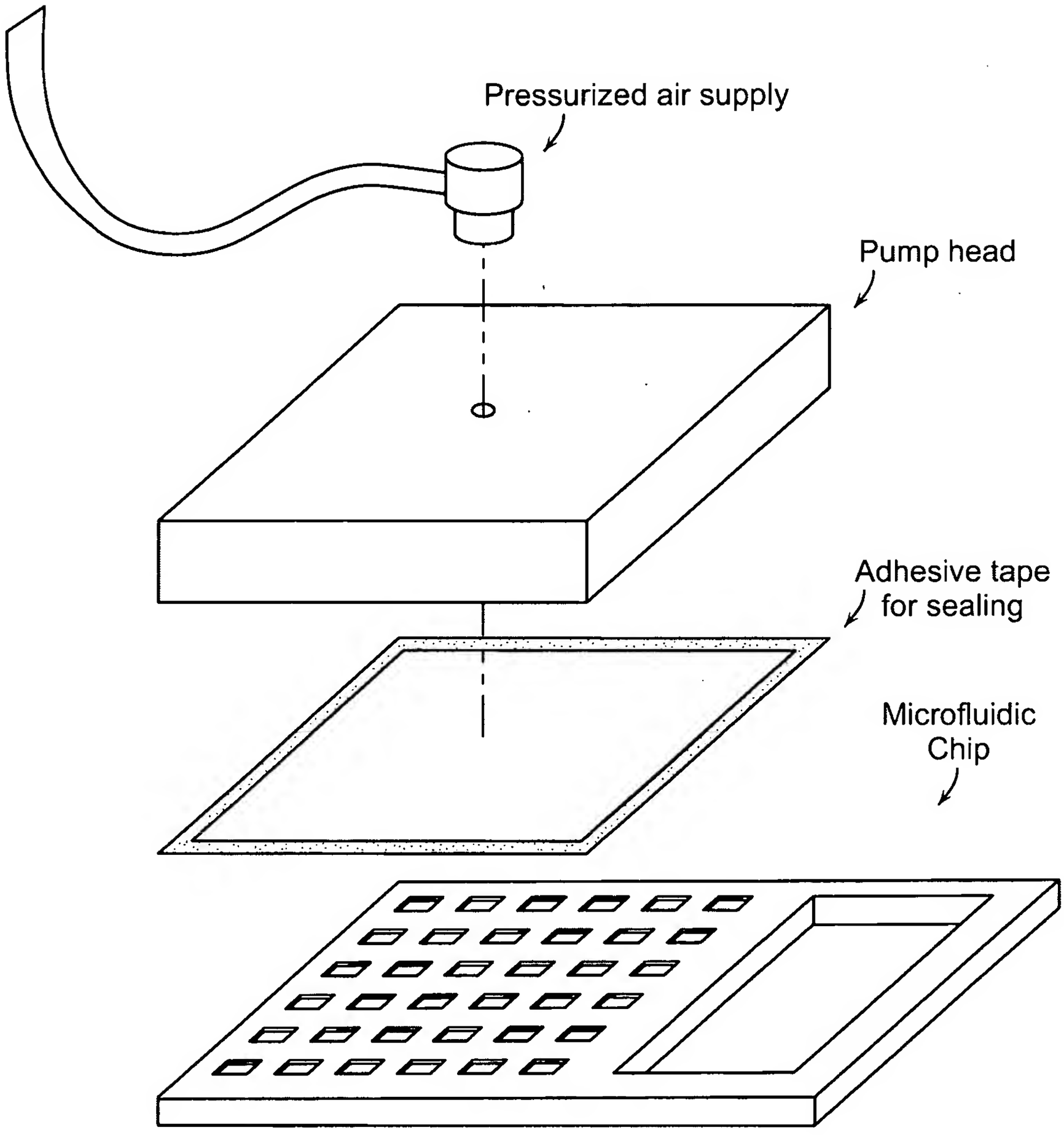
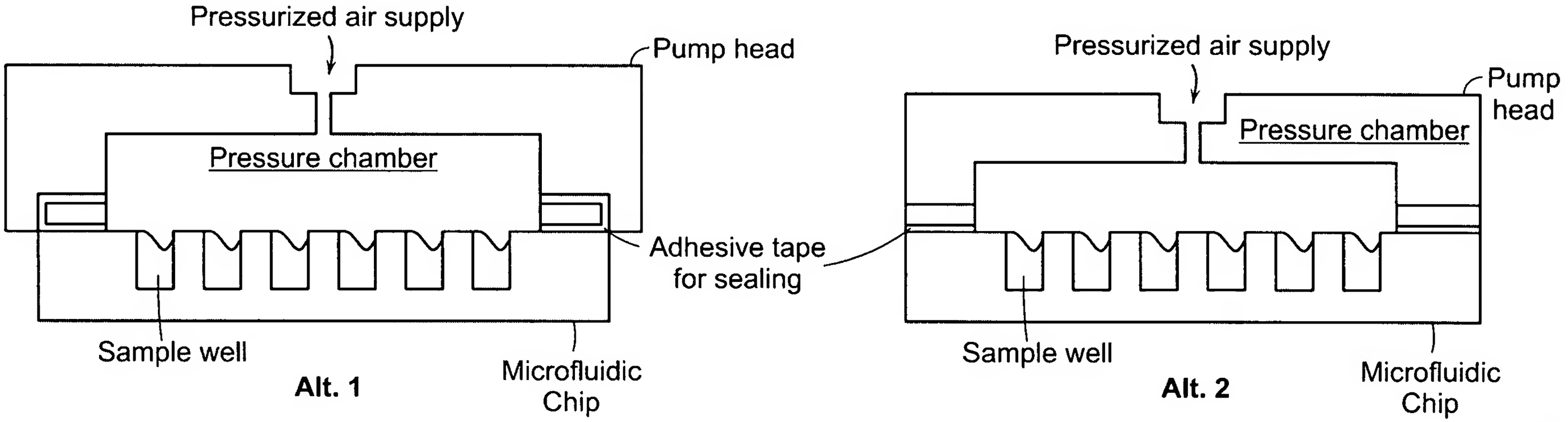

Pressurized air supply
Pump head
Adhesive tape
for sealing
Microfluidic
Chip

FIG. 1A

Side View



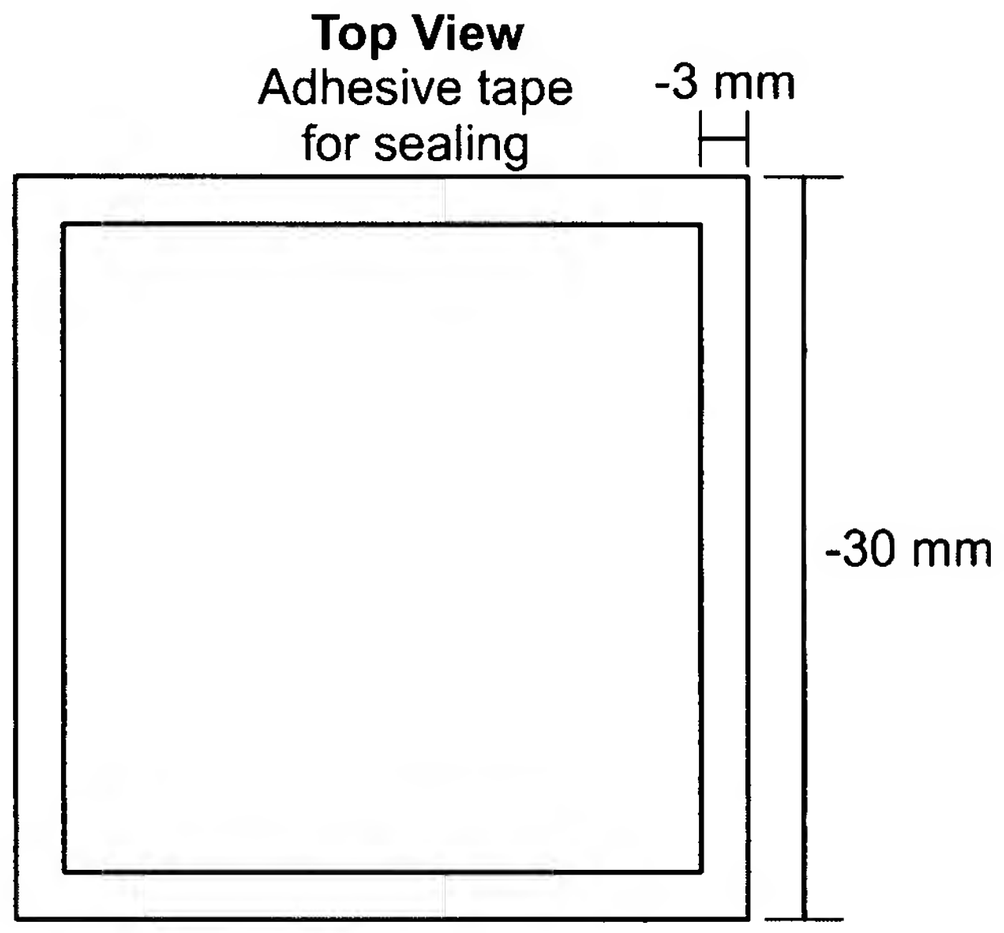


FIG. 1B

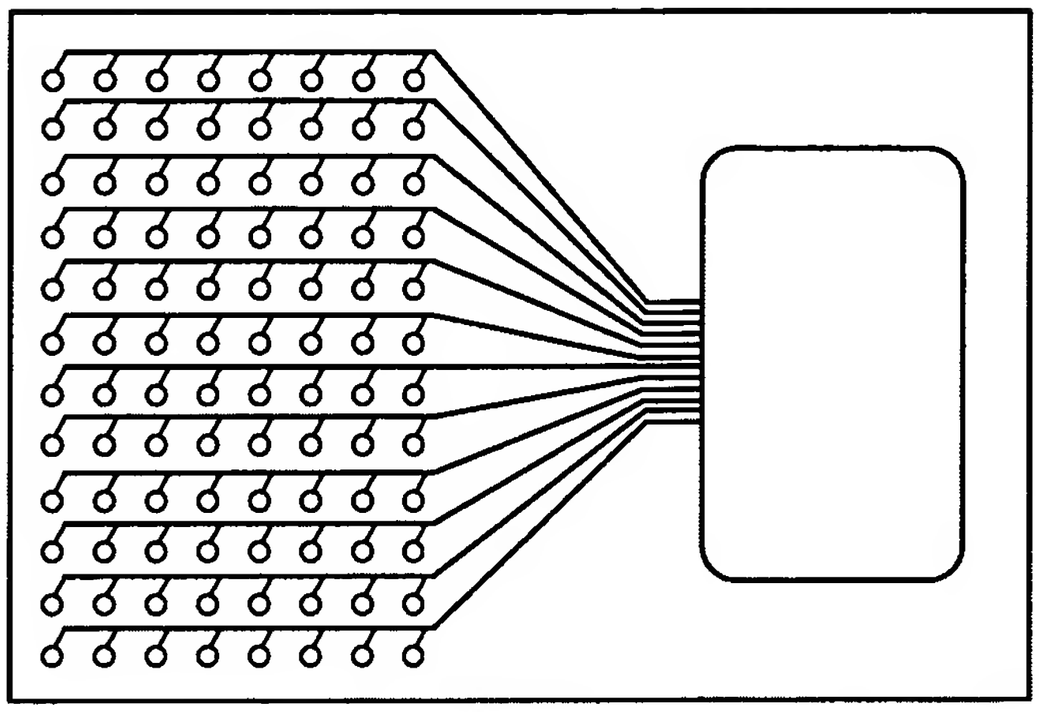


FIG. 2A

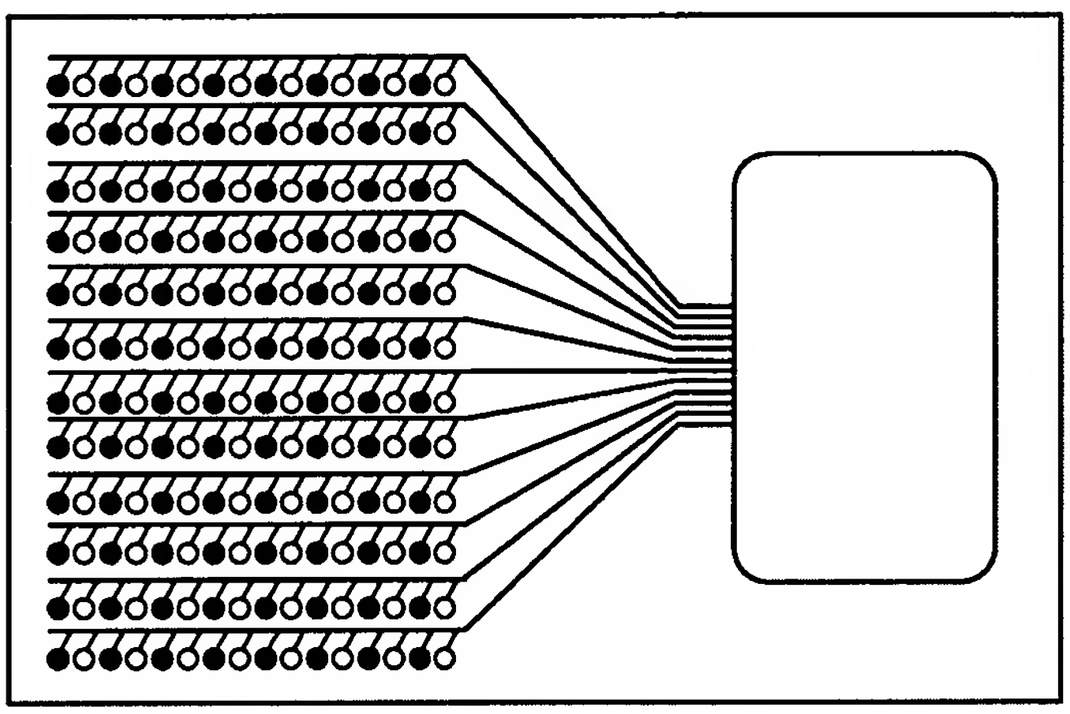


FIG. 2B

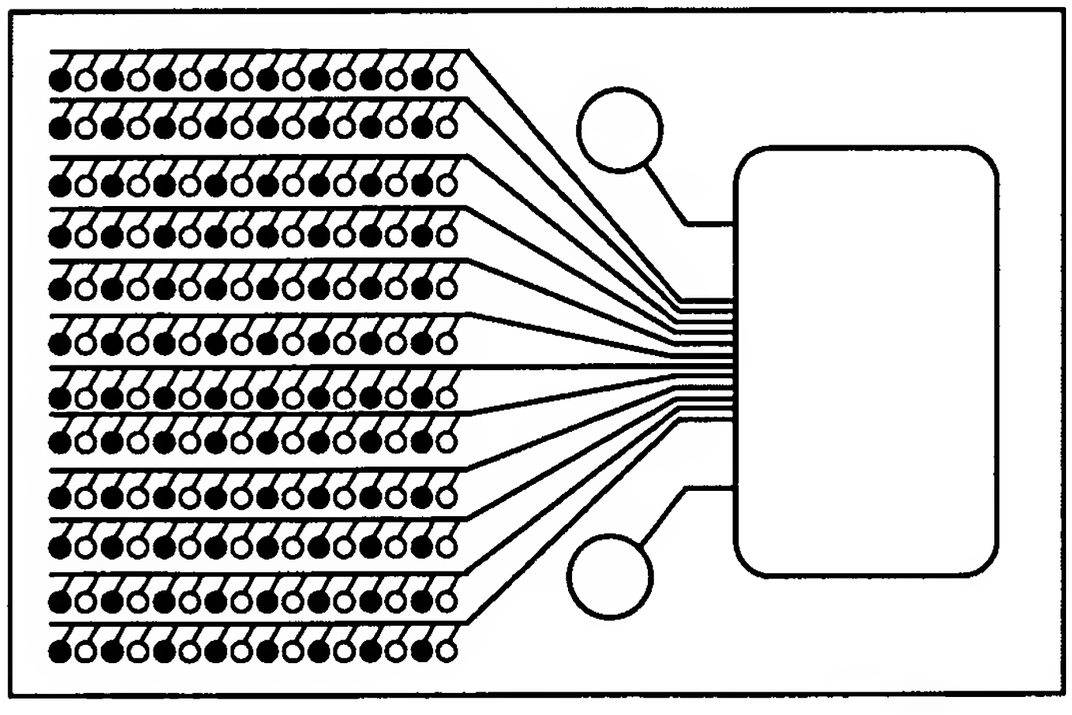


FIG. 2C

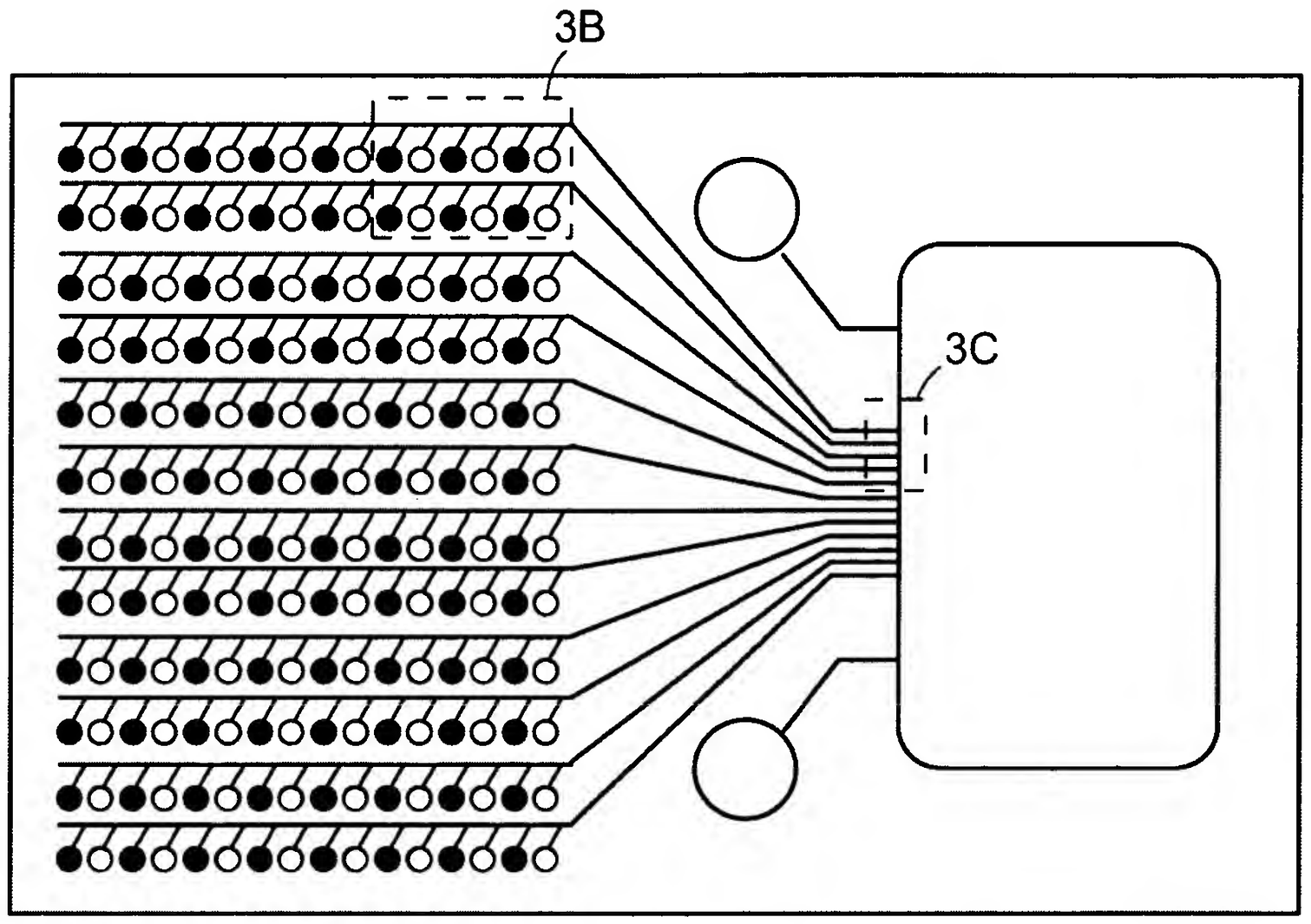


FIG. 3A

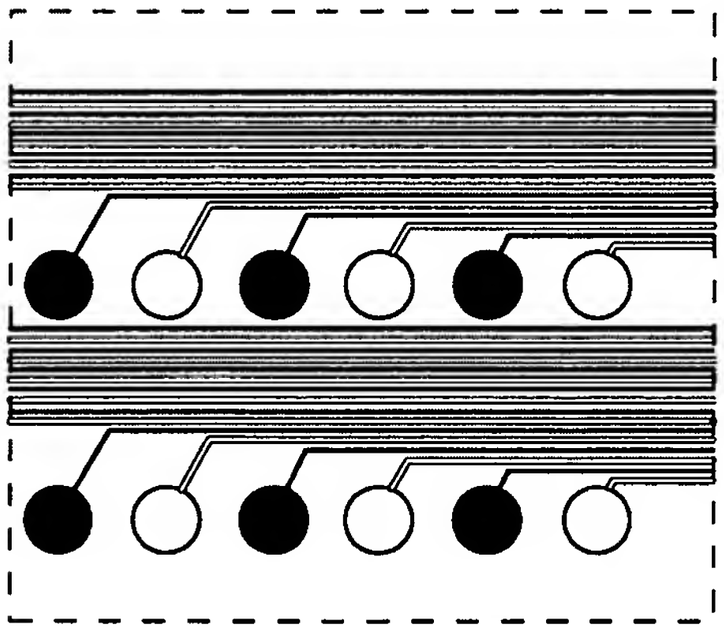


FIG. 3B

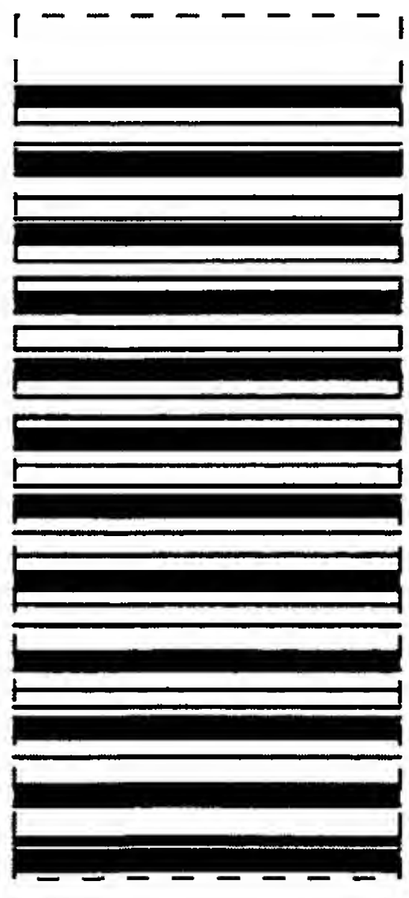


FIG. 3C

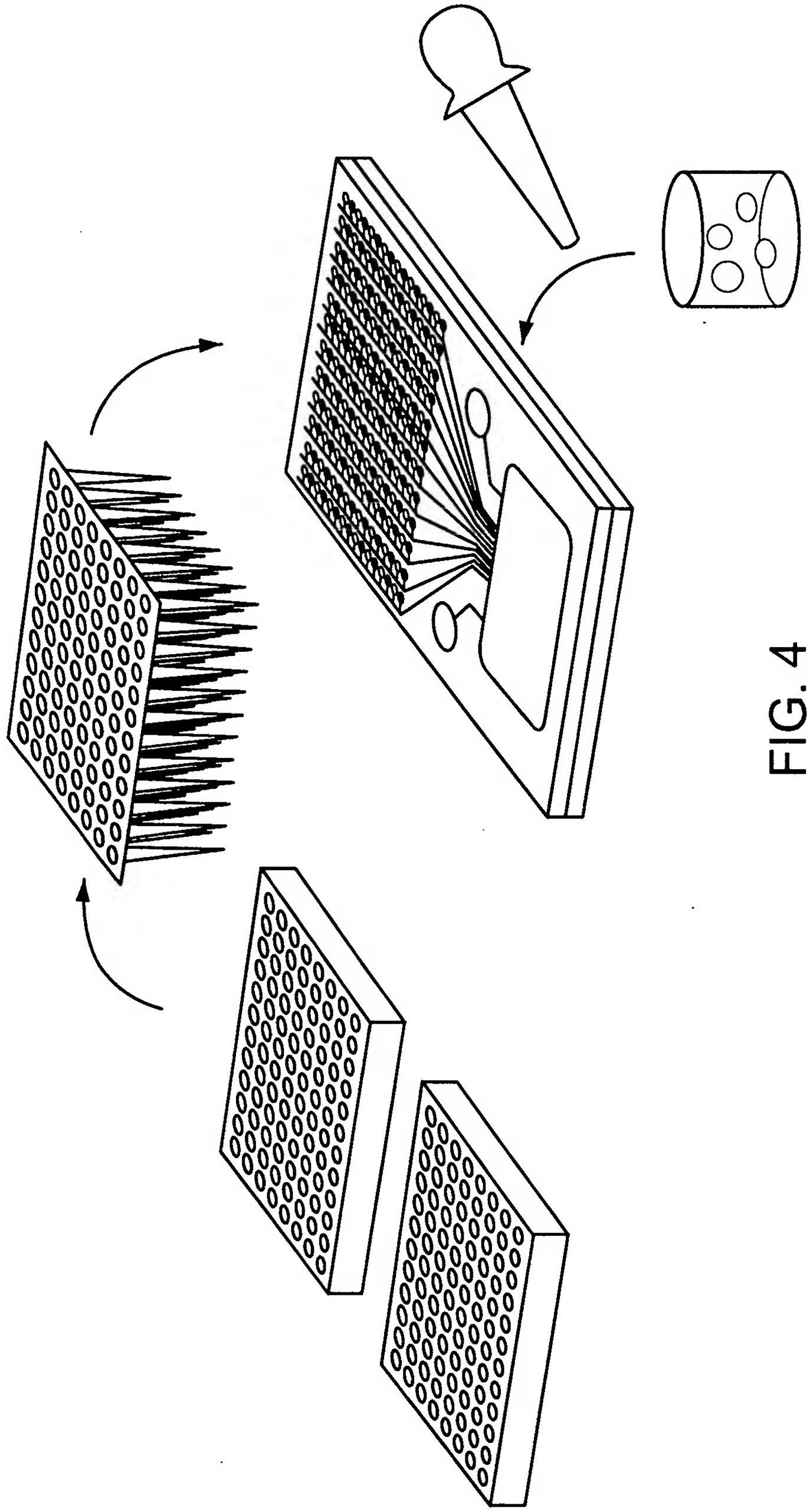


FIG. 4

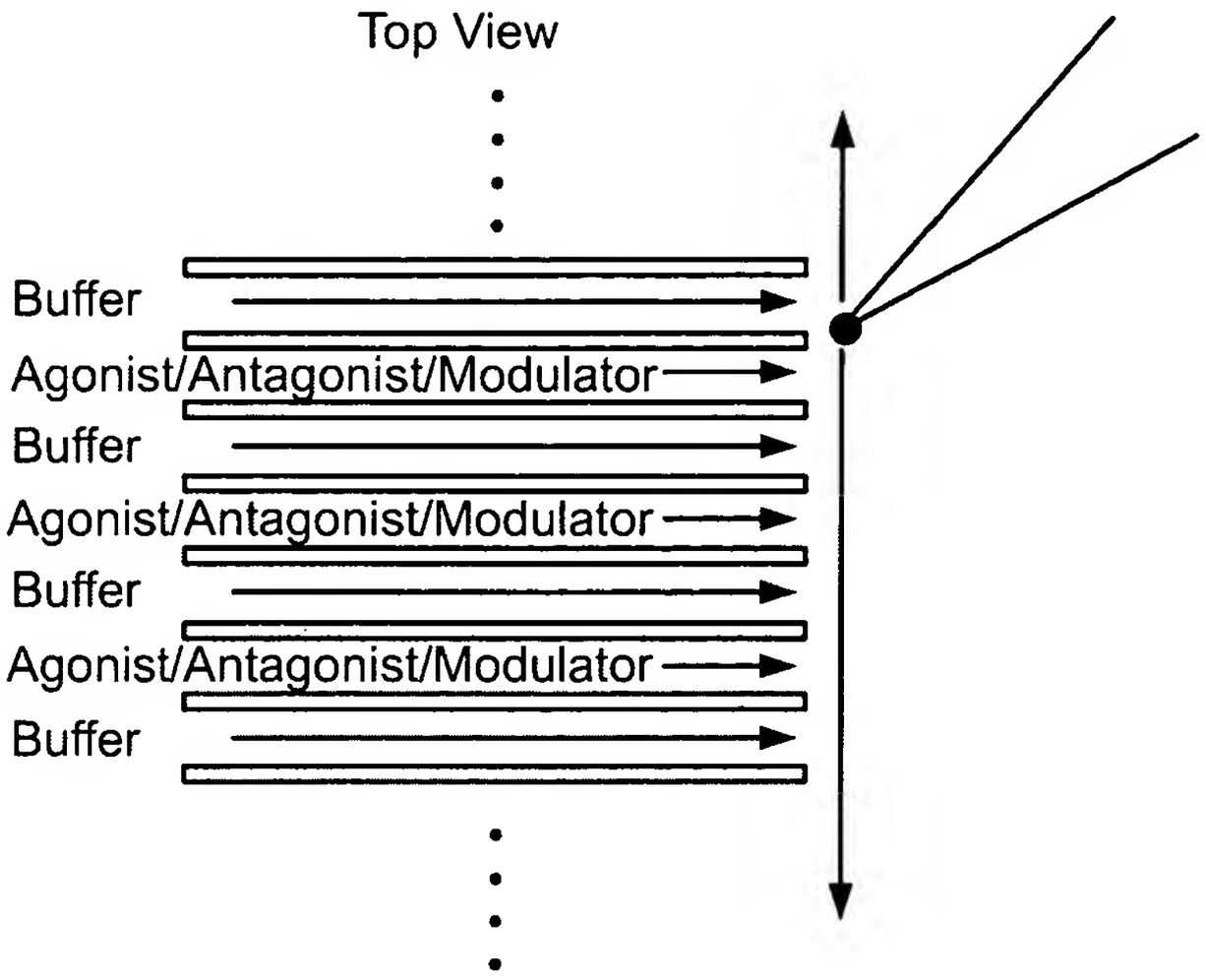


FIG. 5A

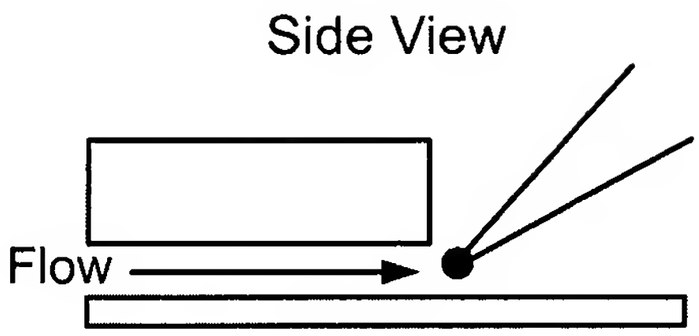


FIG. 5B

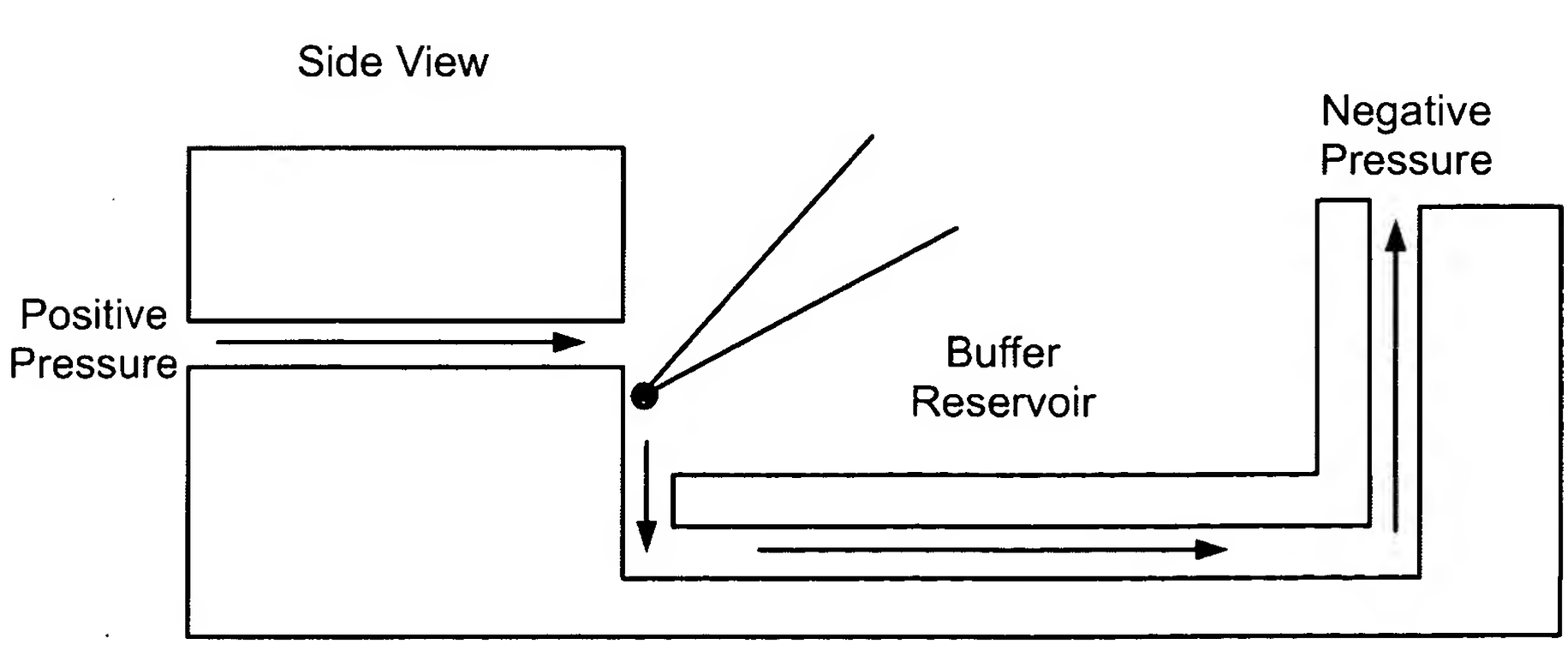


FIG. 5C

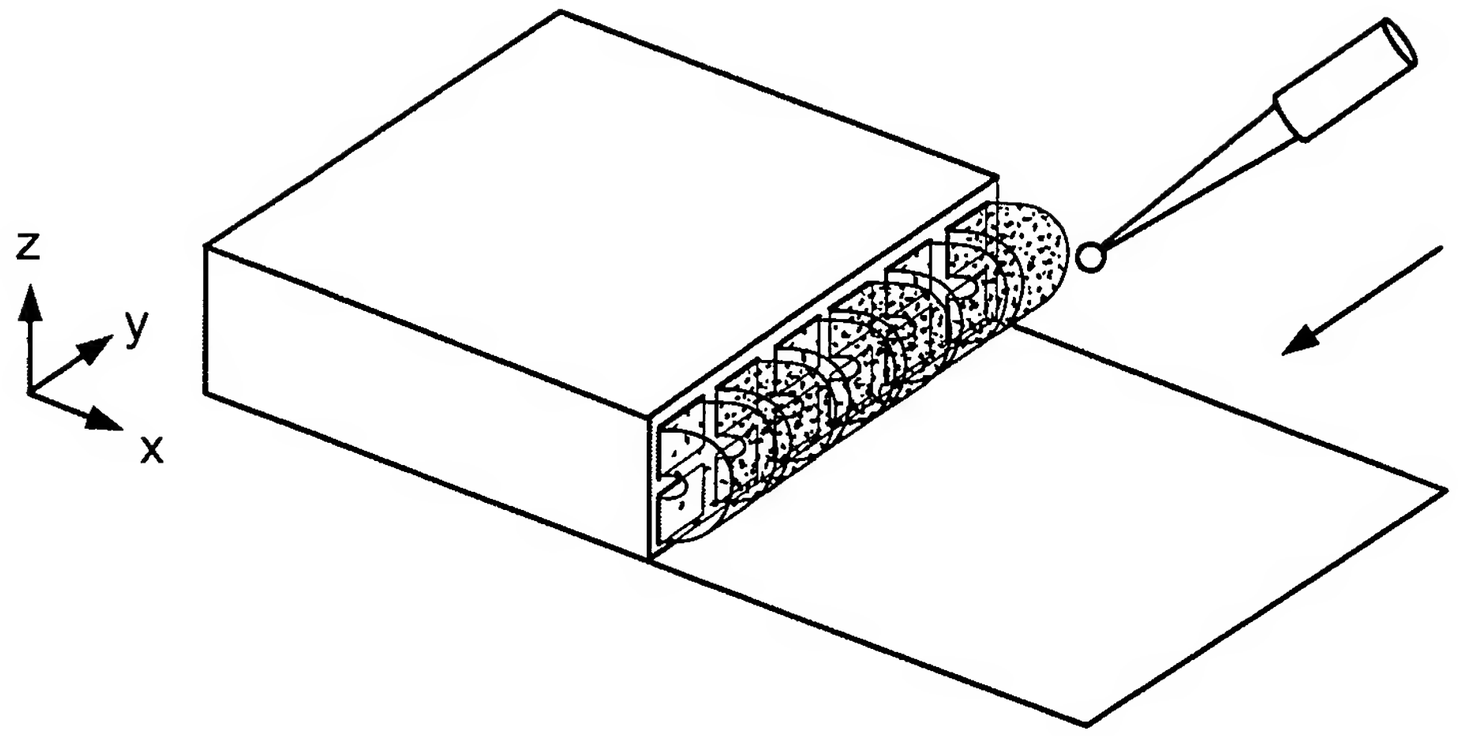


FIG. 5D

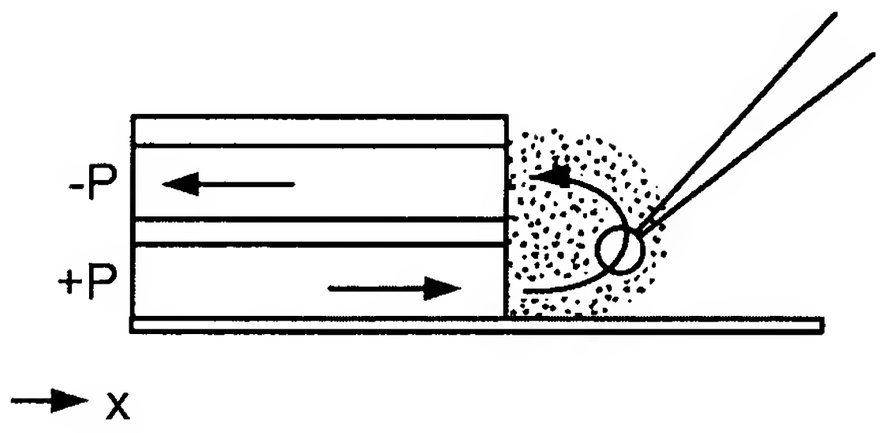


FIG. 5E

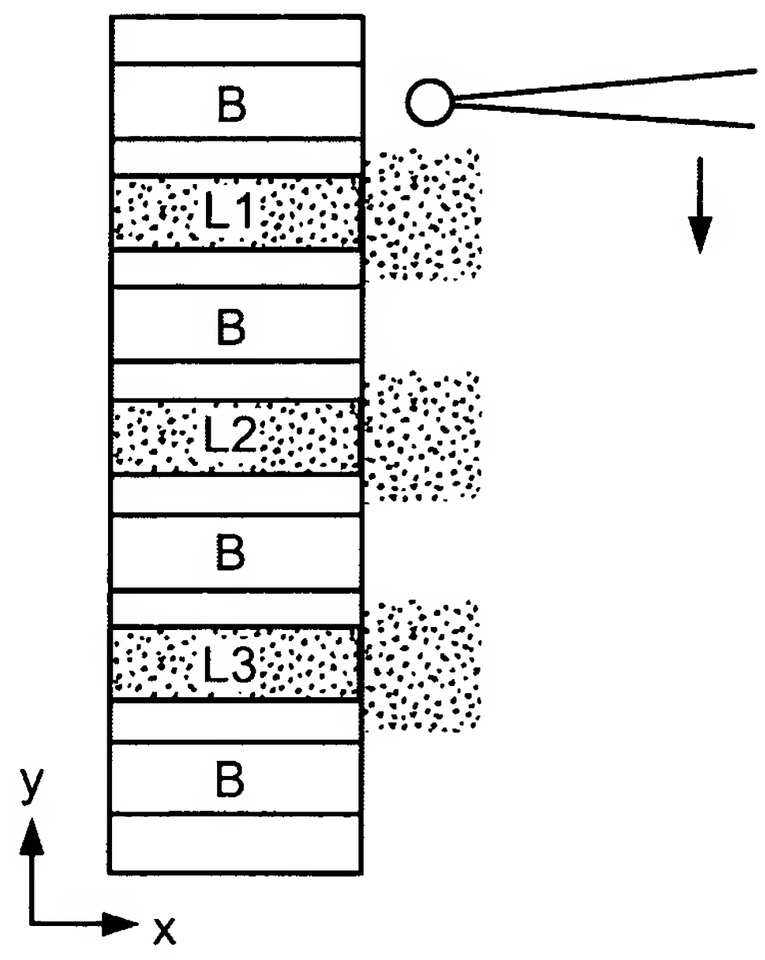


FIG. 5F

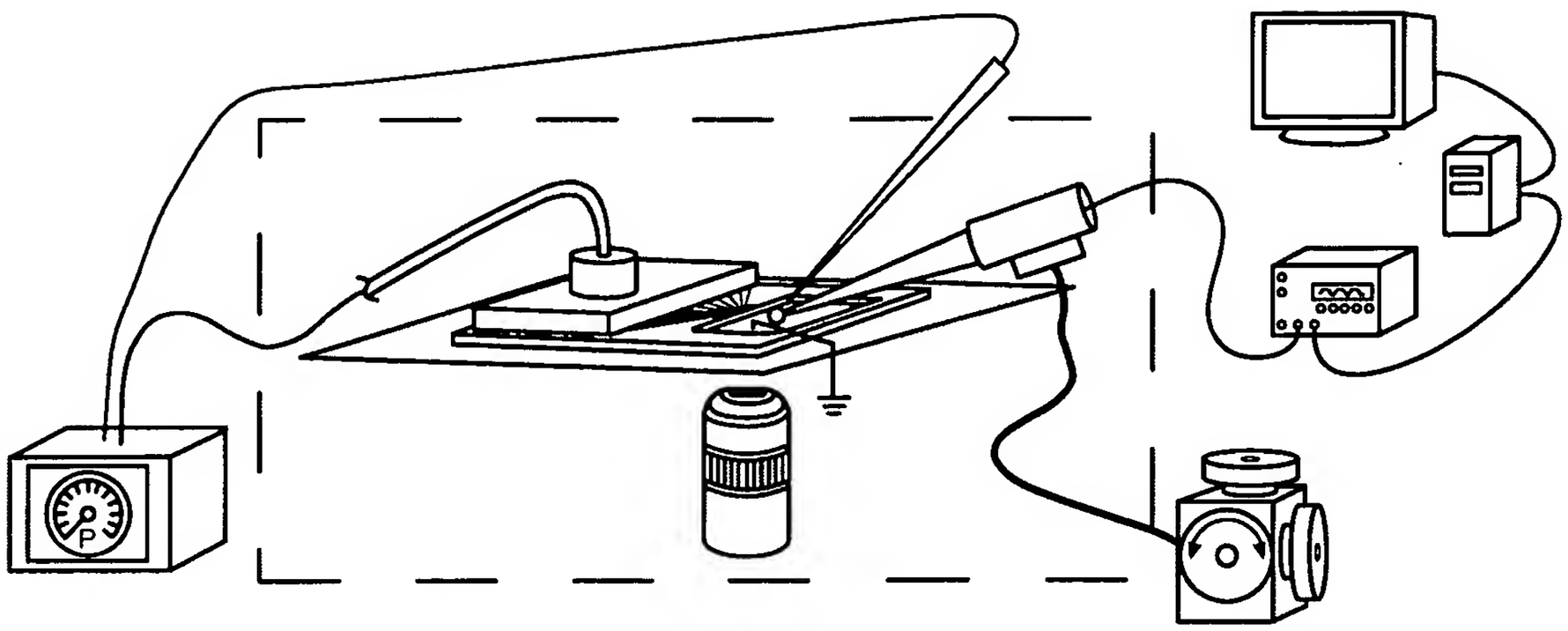


FIG. 6A

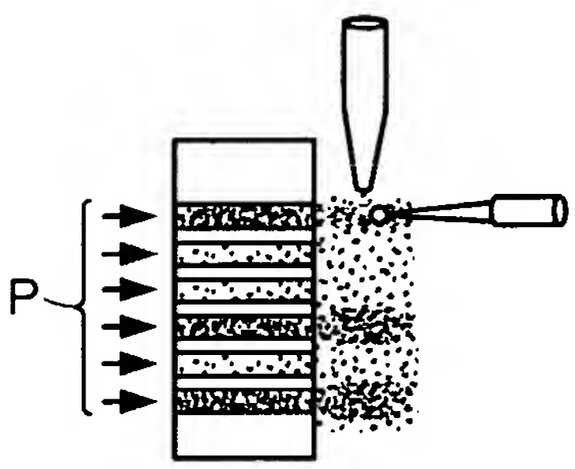


FIG. 6B

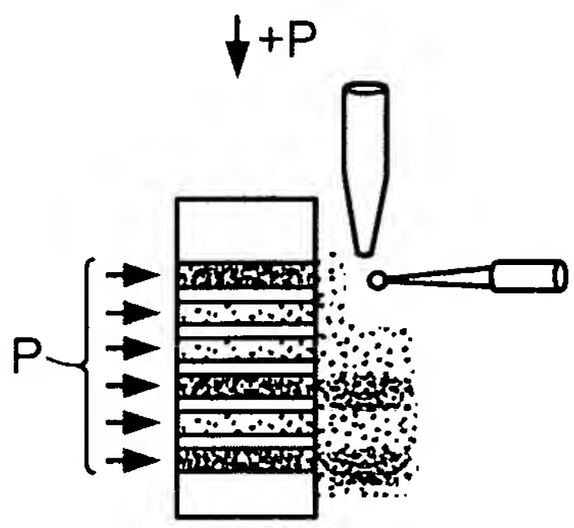


FIG. 6C

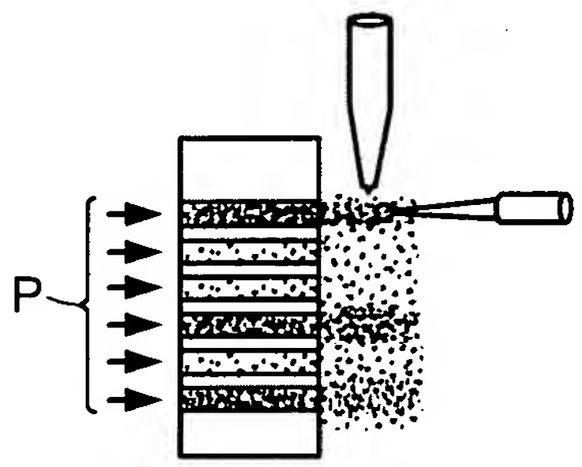


FIG. 6D

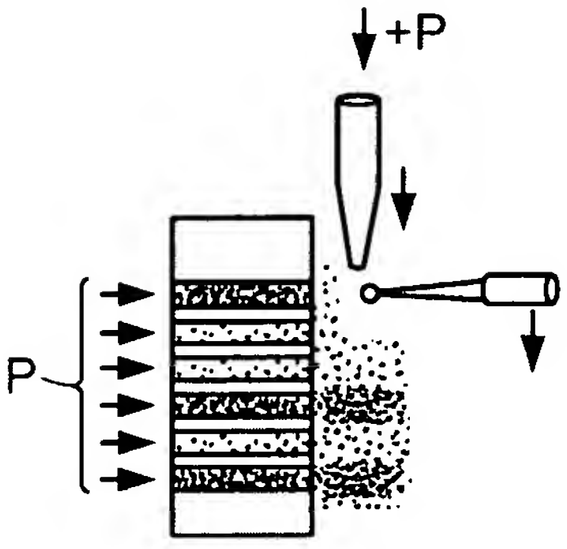


FIG. 6E

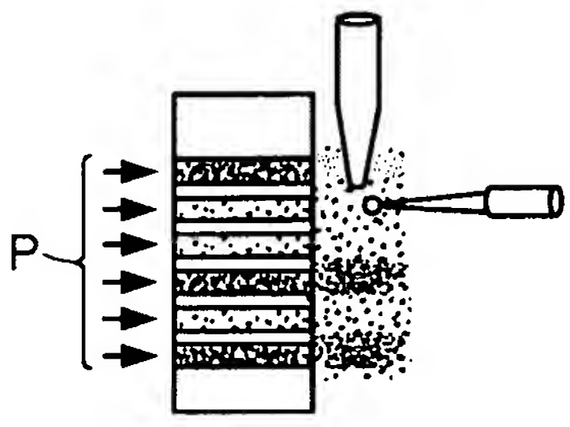


FIG. 6F

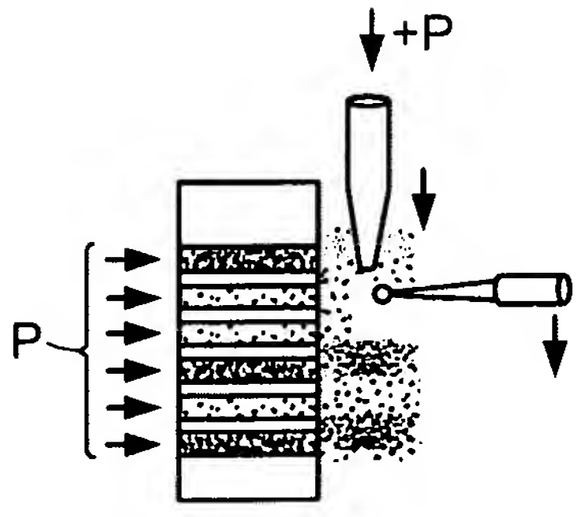


FIG. 6G

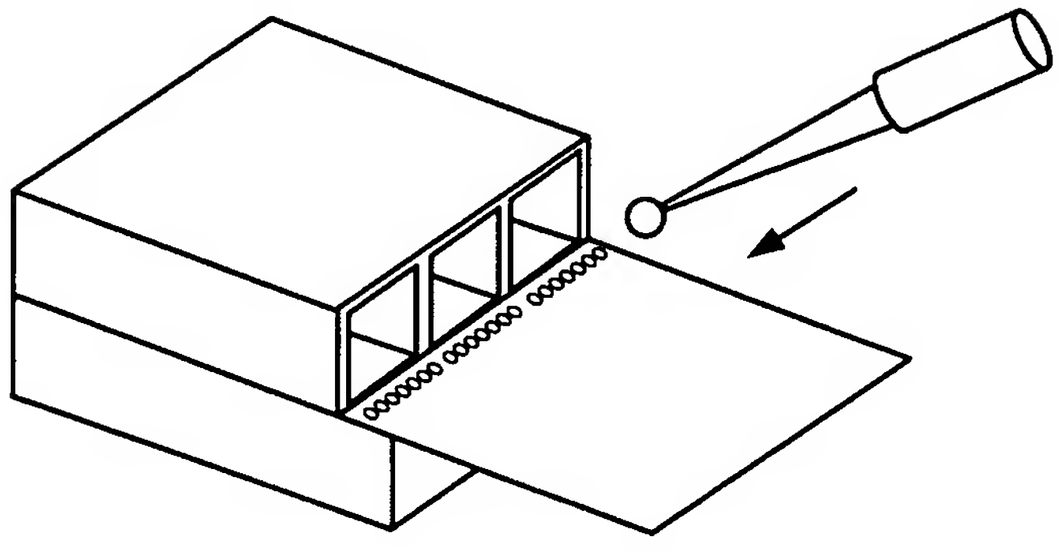


FIG. 6H

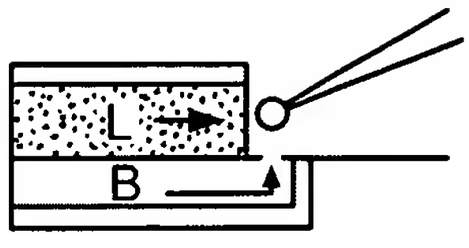


FIG. 6I

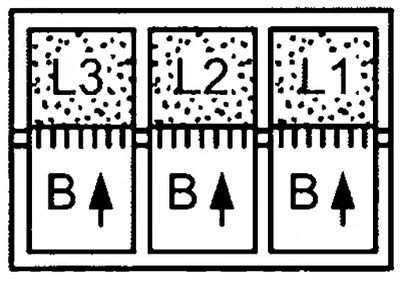


FIG. 6J

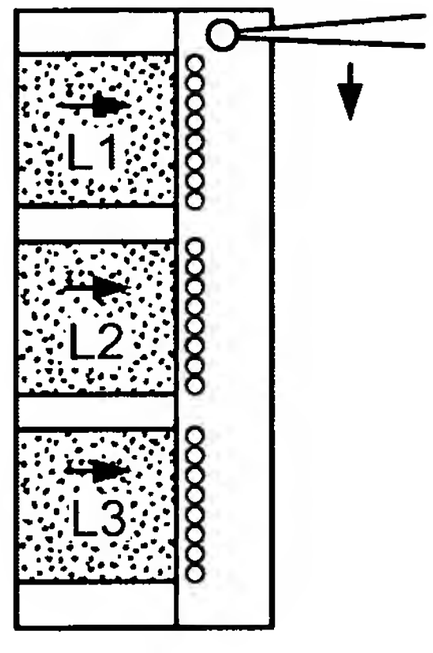


FIG. 6K

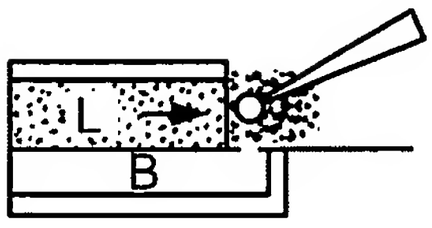


FIG. 6L

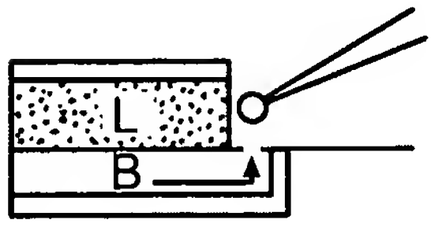


FIG. 6M

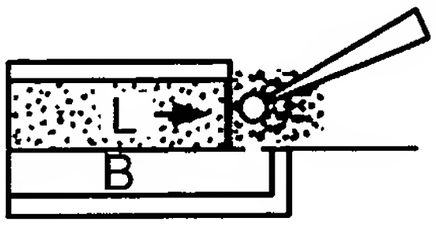


FIG. 6N

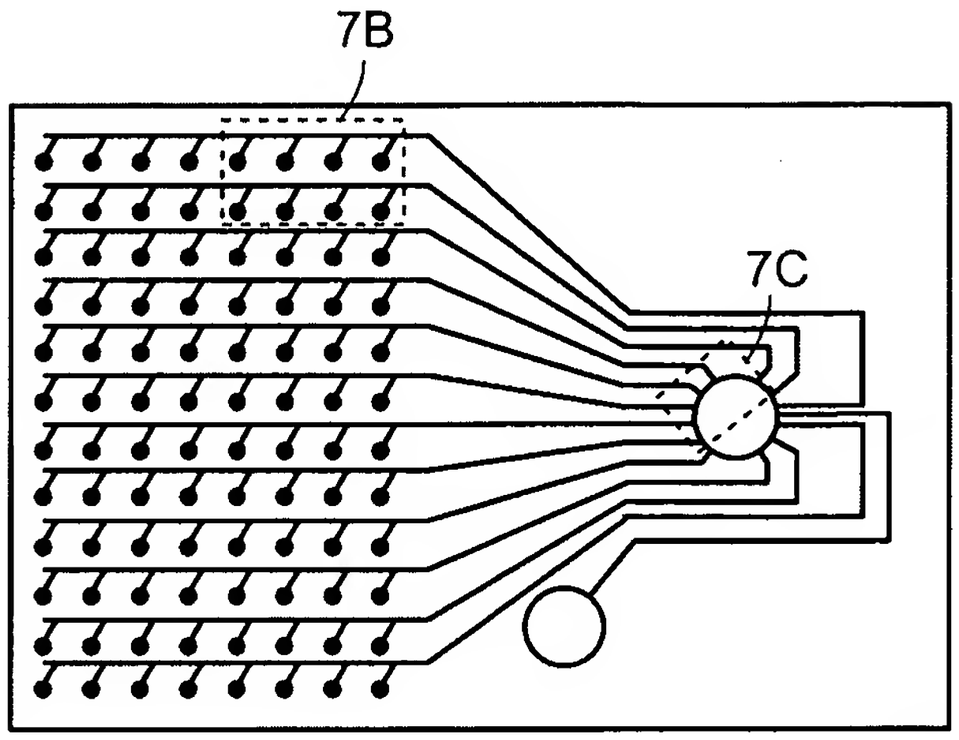


FIG. 7A

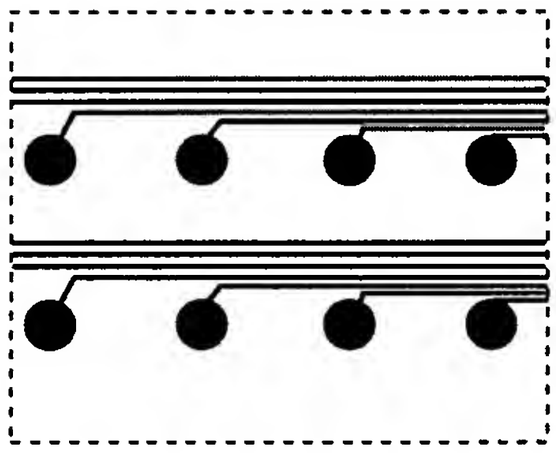


FIG. 7B

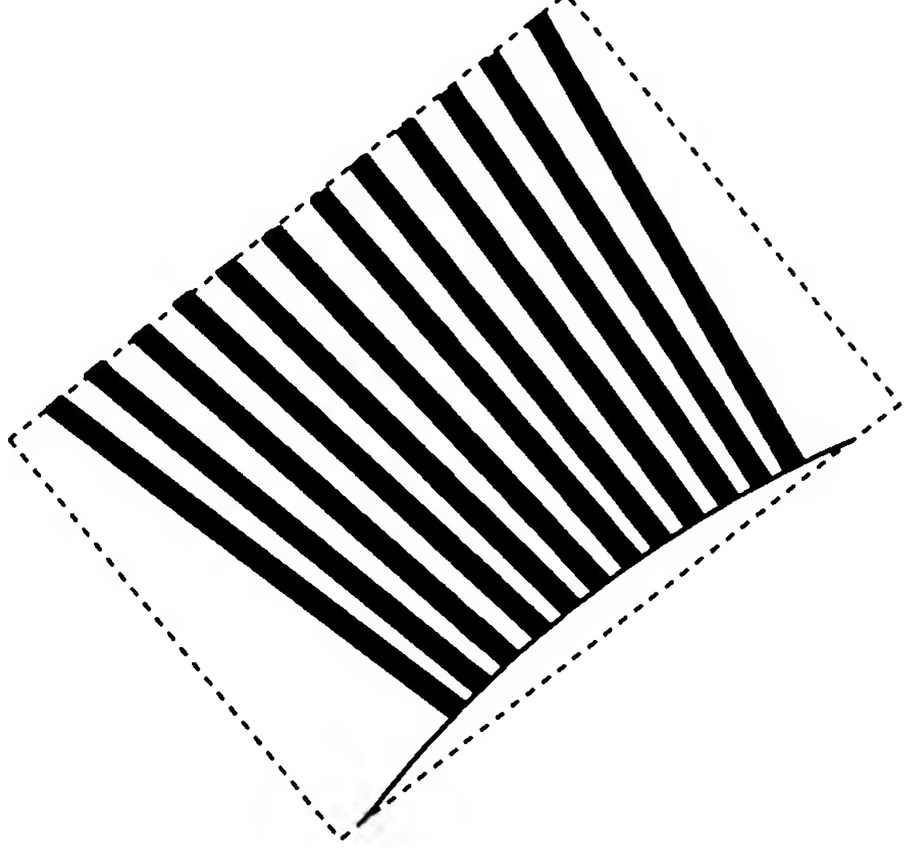


FIG. 7C

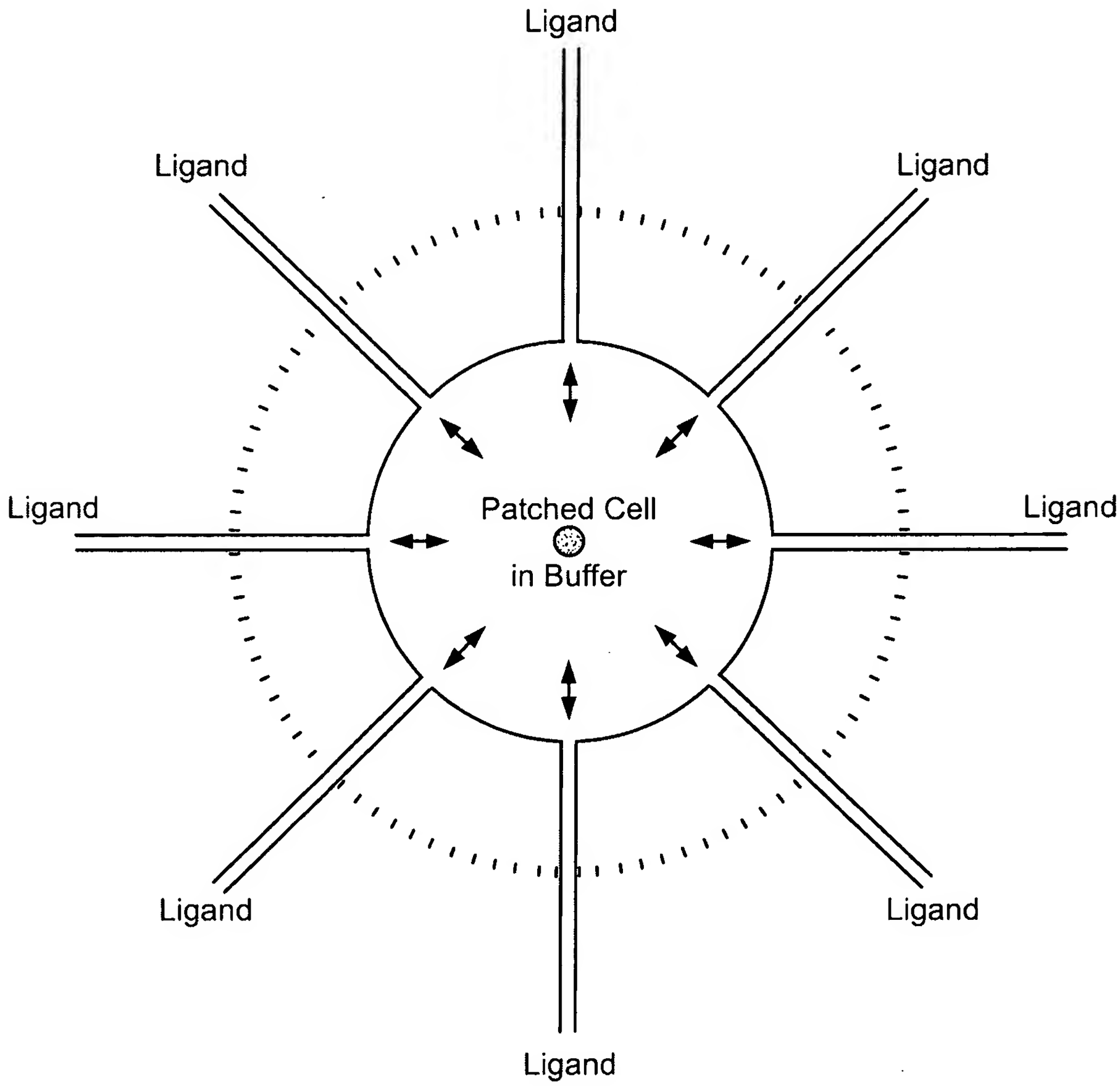

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FIG. 8

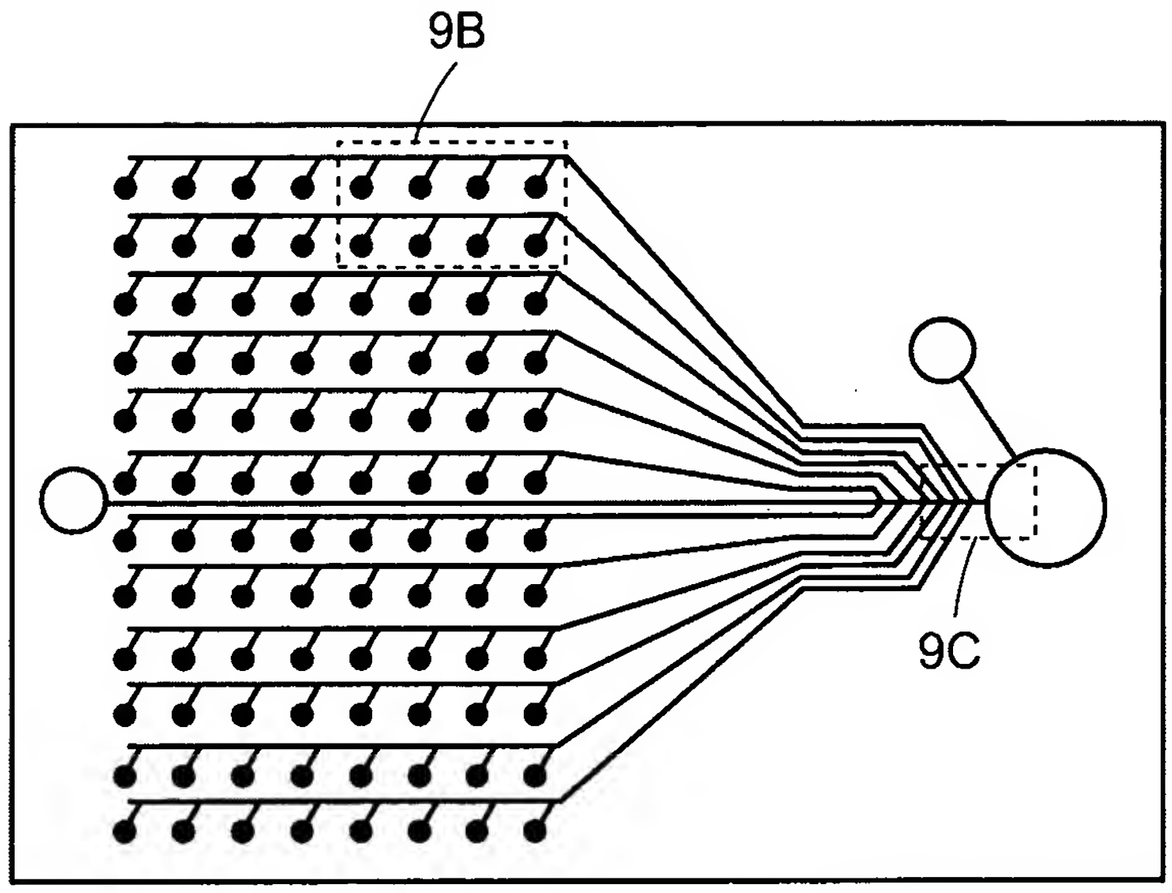

FIG. 9A

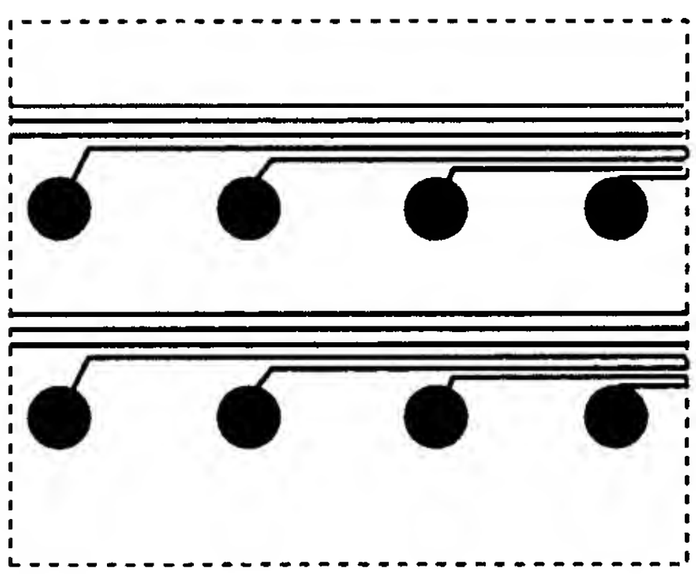

FIG. 9B

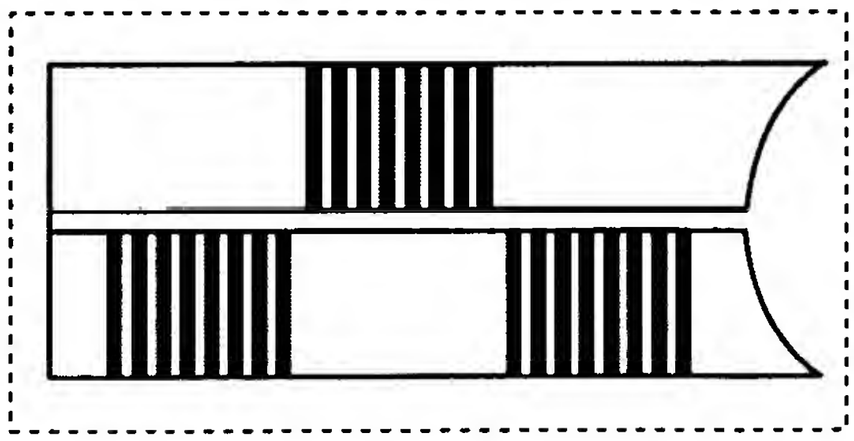

FIG. 9C

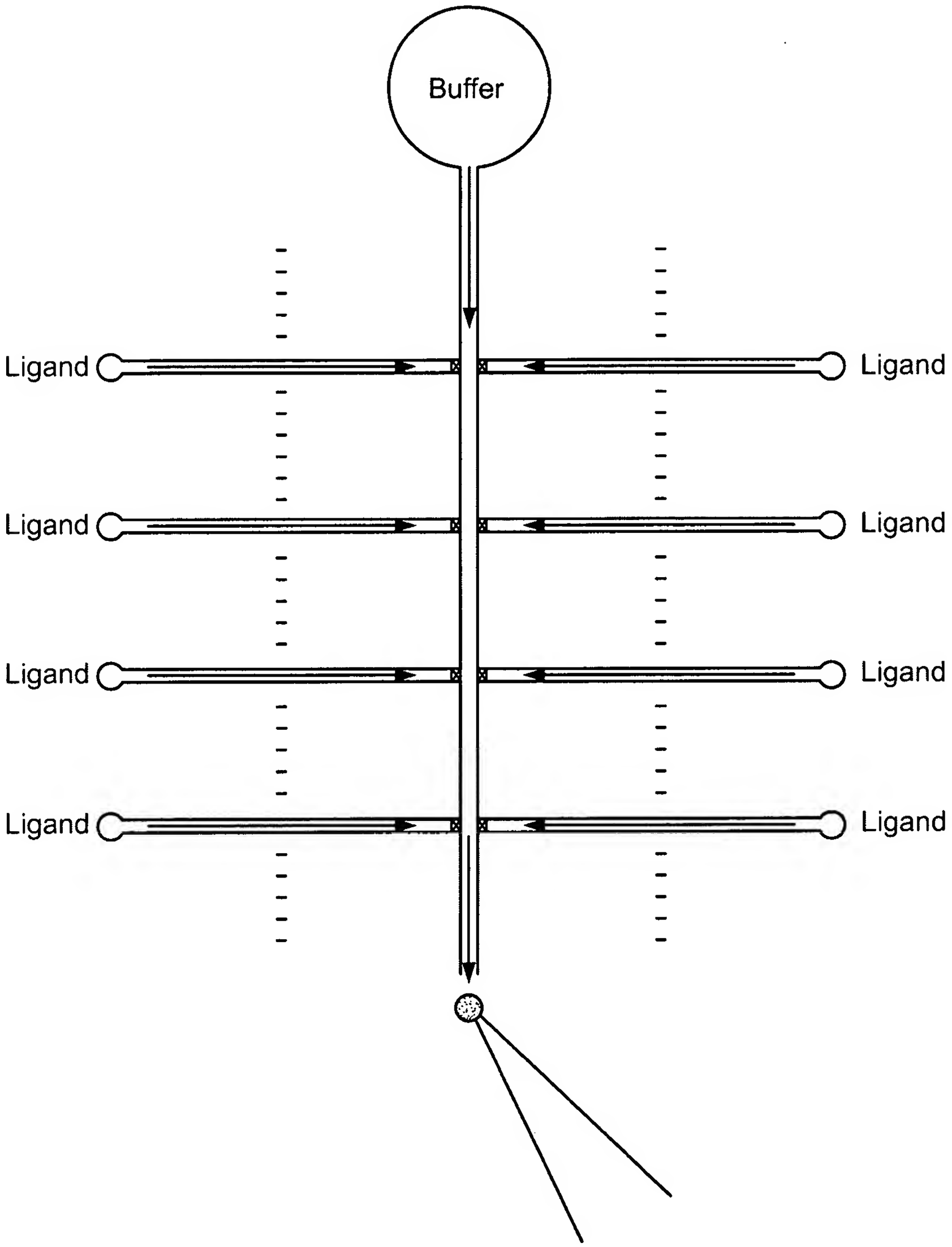
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FIG. 10